

描述 / Descriptions

TO-220FL 塑封封装 N 沟道场效应管。

N-CHANNEL MOSFET in a TO-220FL Plastic Package.

特征 / Features

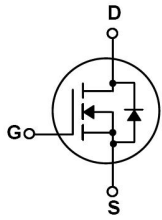
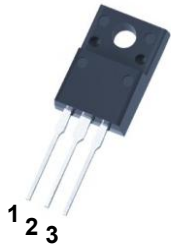
低栅电荷,低反馈电容,开关速度快。

Low gate charge, low crss, fast switching.

用途 / Applications

用于高效 DC/DC 转换和功率开关。

These devices are well suited for high efficiency switching DC/DC converters and switch mode power supplies.

内部等效电路 / Equivalent Circuit**引脚排列 / Pinning**

PIN1 : G

PIN 2 : D

PIN 3 : S

放大及印章代码 / h_{FE} Classifications & Marking

见印章说明。 See Marking Instructions.

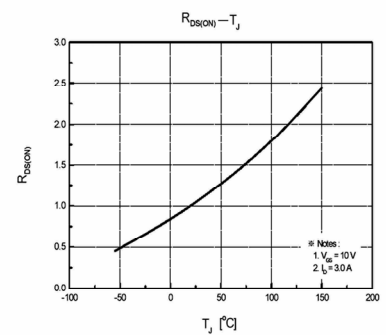
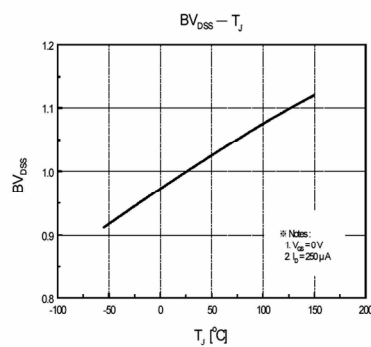
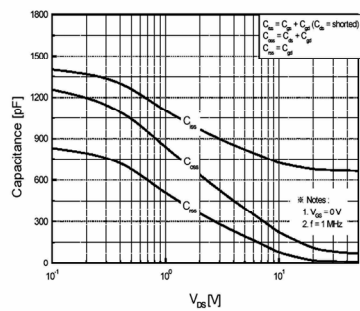
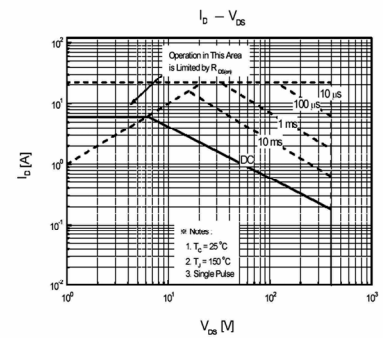
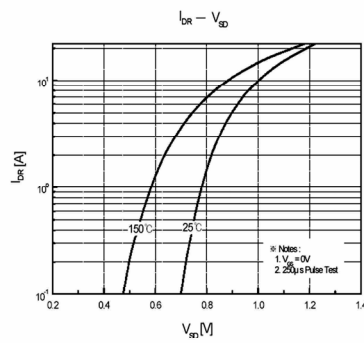
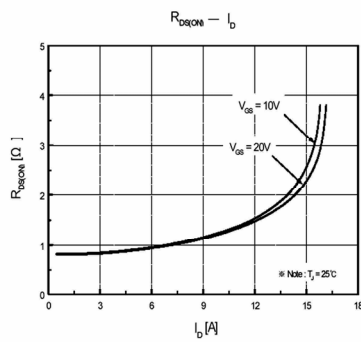
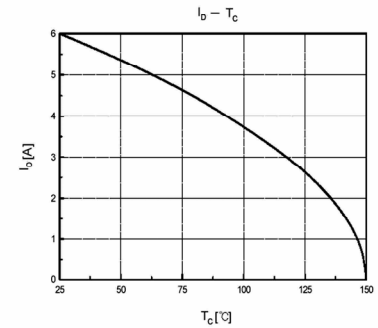
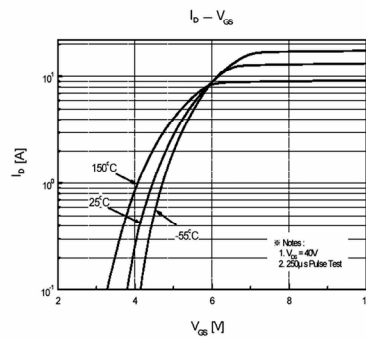
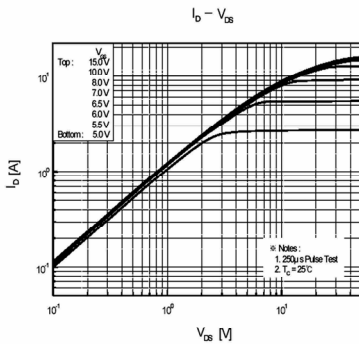
极限参数 / Absolute Maximum Ratings(Ta=25°C)

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Drain-Source Voltage	V_{DS}	400	V
Drain Current	$I_D(T_C=25^{\circ}\text{C})$	6.0	A
	$I_D(T_C=100^{\circ}\text{C})$	3.6	A
Pulsed Drain Current	I_{DM}	24	A
Gate-Source Voltage	V_{GS}	± 30	V
Avalanche Current	I_{AR}	5.5	A
Single Pulsed Avalanche Energy	E_{AS}	390	mJ
Repetitive Avalanche Energy	E_{AR}	8.75	mJ
Total Power Dissipation	$P_D(T_C=25^{\circ}\text{C})$	37	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^{\circ}\text{C}$
Junction-to-Case	$T_{\theta JC}$	3.37	$^{\circ}\text{C/W}$
Junction-to-Ambient	$T_{\theta JA}$	63	$^{\circ}\text{C/W}$

电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Zero Gate Voltage Drain Current	BV_{DSS}	$V_{GS}=0V$ $I_D=250\mu A$	400			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=400V$ $V_{GS}=0V$			10	μA
		$V_{DS}=320V$ $T_C=125^{\circ}\text{C}$			100	μA
Gate-Body Leakage Current Forward	I_{GSS}	$V_{GS}=\pm 30V$ $V_{DS}=0V$			± 0.1	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V$ $I_D=3.0A$		0.78	0.95	Ω
Forward Transconductance	g_{FS}	$V_{DS}=40V$ $I_D=3.0A$		4.5		S
Forward On Voltage	V_{SD}	$V_{GS}=0V$ $I_S=6.0A$			1.5	V
Input Capacitance	C_{iss}	$V_{DS}=25V$ $V_{GS}=0V$ $f=1.0\text{MHz}$		670	870	pF
Output Capacitance	C_{oss}			95	125	
Reverse Transfer Capacitance	C_{rss}			16	21	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=200V$ $I_D=6.0A$ $R_G=25\Omega$		20	50	ns
Turn-On Rise Time	t_r			50	110	
Turn-Off Delay Time	$t_{d(off)}$			90	190	
Turn-Off Fall Time	t_f			55	120	

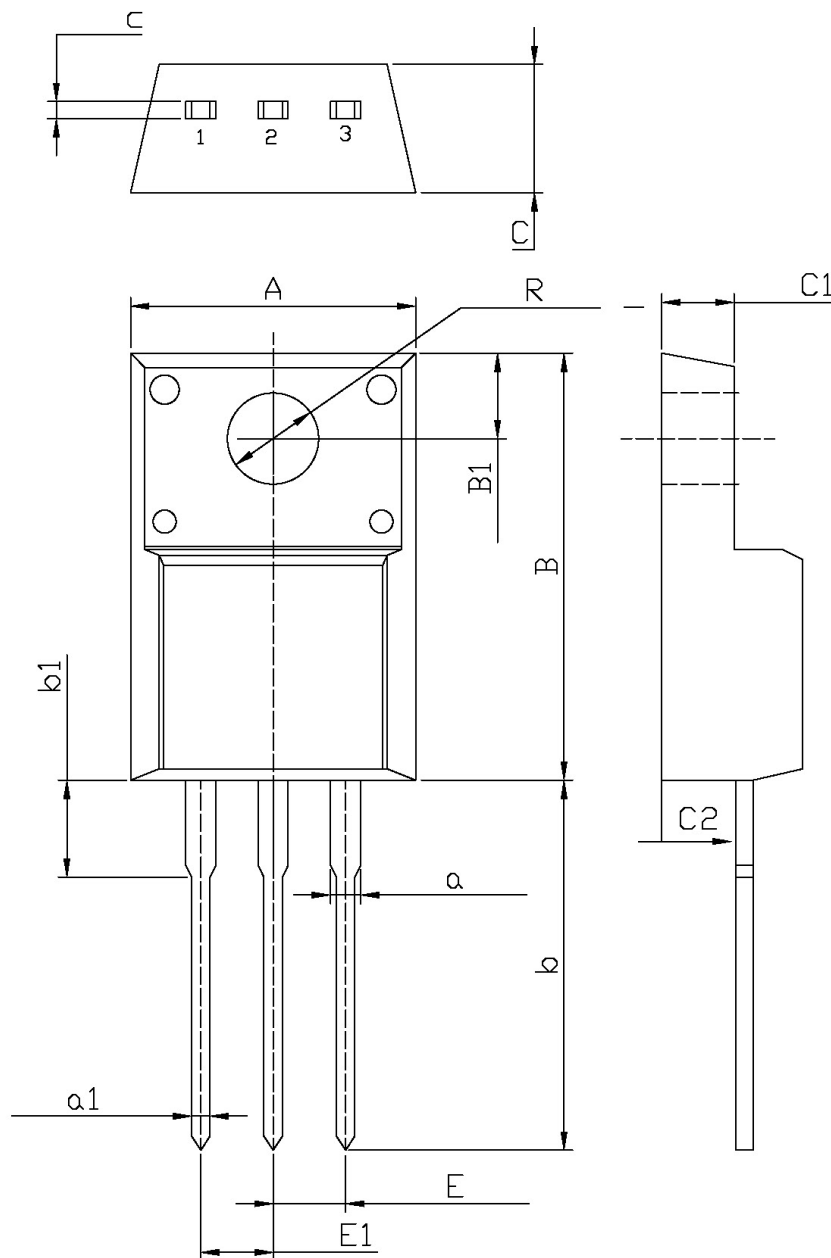
电参数曲线图 / Electrical Characteristic Curve



外形尺寸图 / Package Dimensions

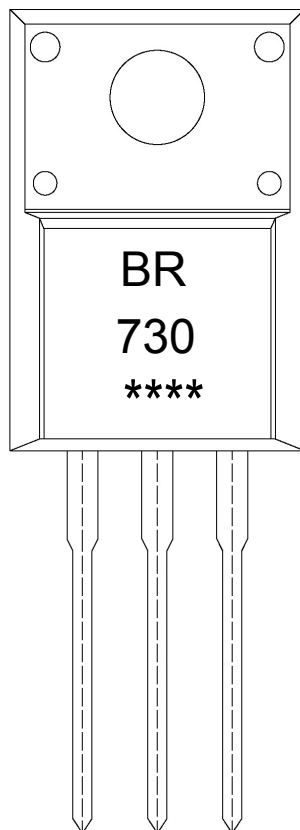
TQ-220FL

单位: mm



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
C	4.5	4.9	b1	2.90	3.90
C	0.4	0.6	a	1.08	1.48
A	9.96	10.36	a1	0.70	0.90
B	15.67	16.07	E	2.34	2.74
B1	3.30	3.50	E1	2.34	2.74
R	3.08	3.28	C1	2.34	2.74
b	12.48	13.48	C2	2.56	2.96

印章说明 / Marking Instructions



说明：

BR： 为公司代码

730： 为产品型号

****： 为生产批号代码，随生产批号变化。

Note:

BR: Company Code

730: Product Type.

****: Lot No. Code, code change with Lot No.

波峰焊温度曲线图(无铅) / Temperature Profile for Dip Soldering(Pb-Free)



说明：

- 1、预热温度 25 ~ 150°C，时间 60 ~ 90sec;
- 2、峰值温度 255±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2 ~ 10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:255±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：270±5°C

时间：10±1 sec.

Temp.:270±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

套管包装 / TUBE

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-220FL	50	20	1,000	5	5,000	532×33×7.0	555×164×50	575×290×180

使用说明 / Notices